WinhiSemi

VUGA044N18TA



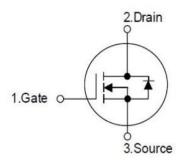
$9m\Omega$, 16V, N-Channel Power MOSFET

VUGA044N18TA

General Description

VUGA044N18TA N-Channel MOSFET is based on unique device design to achieve low RDS_(ON), low gate charge, fast switching and excellent avalanche characteristics.

Symbol



Symbol of VUGA044N18TA

Features

- Low RDS(ON) & FOM
- $\blacksquare R_{DS(ON) max} = 9m\Omega@V_{GS} = 4.5V$
- Extremely low switching loss
- Fast switching and soft recovery

Package Type



Application

- Charging Circuit
- Battery Applications
- Synchronous Rectification
- High Frequency Switching

Package Type of VUGA044N18TA

Ordering Information

Product Name	Package	Marking
VUGA044N18TA	PDFN3.3*3.3	44N18

9mΩ, 16V, N-Channel Power MOSFET

VUGA044N18TA

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	16	V
Gate-Source Voltage	V_{GS}	±8	V
Continuous Drain Current ^{Note 1} , T _C =25°C	I_D	22	A
Pulsed Drain Current ^{Note 2}	I_{DM}	66	A
Max Power Dissipation Note 3, T _C =25°C	P _D	19.4	W
Avalanche Current, Single Pulse Note 5	I _{AS}	15.41	A
Avalanche Energy, Single Pulse Note 5	E _{AS}	35.62	mJ
Operation Junction temperature	T _J	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit	
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$		6.45		°C/W	
Thermal Resistance, Junction-to-Ambient ^{Note4}	$R_{ heta JA}$		62] °C/W	

Notes:

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_D is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with Ta=25 °C.
- 5) V_{DS} =15V, V_{GS} =4.5V, L=0.3mH, Rg=25Ω, starting T_{J} =25 °C.

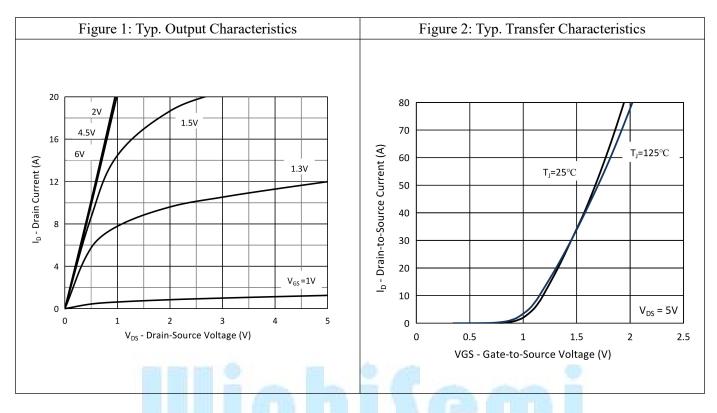
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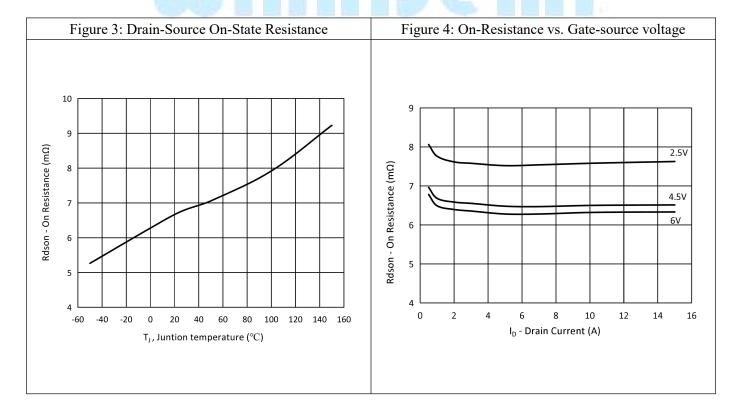
VUGA044N18TA

Electrical Characteristics (T_J= 25 °C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	16			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=16V, V_{GS}=0V$			1	uA
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm 8V, V_{DS}=0V$			±100	nA
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS}=V_{GS}$, $I_D=250uA$	0.4	0.6	0.9	V
	D	V_{GS} =4.5V, I_{D} =5A		6.7	9	$m\Omega$
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =15A		6.7	9	mΩ
Gate Resistance	R_G	f=1MHz, open drain		0.42		Ω
Dynamic Characteristics			•			
Input Capacitance	Ciss	V _{GS} =0V		814.9		pF
Output Capacitance	Coss	$V_{DS}=10V$		425		pF
Reverse Transfer Capacitance	C _{rss}	f=1MHz		200.8		pF
Turn-on Delay Time	t _{d(on)}	V _{DS} =15V		7.9		
Rise Time	$t_{\rm r}$	$V_{GS}=4.5V$		2.7		
Turn-off Delay Time	t _{d(off)}	$I_D=6A$		27.2		ns
Fall Time	t_{f}	$R_G=3\Omega$		6.5		
Switching Characteristics	Switching Characteristics					
Total Gate Charge (@VGS=8V)	Qg	V 0.4 0V		18.67		
Total Gate Charge (@VGS=4.5V)	Qg	V_{GS} =0 to 8V V_{DS} =10V		10.32		C
Gate to Source Charge	Q_{gs}			1.44		nC
Gate to Drain Charge	Q_{gd}	$I_D=15A$		2.39		
Reverse Diode Characteristics						
Drain-Source Diode Forward Voltage	V_{SD}	V _{GS} =0V, I _{SD} =12A		0.79	1.2	V
Reverse Recovery Time	t _{rr}	V _{DS} =10V		26.83		ns
Reverse Recovery Charge	Qrr	$I_F=12A$		12.06		nC
Peak Reverse Recovery Current	I _{rrm}	di/dt=100A/us		0.76		A

Typical Performance Characteristics

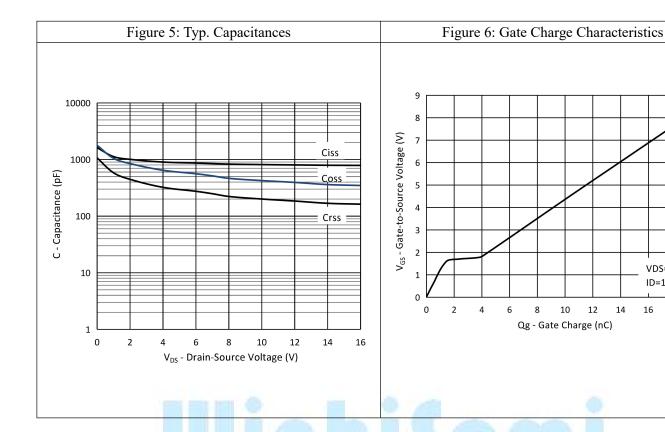


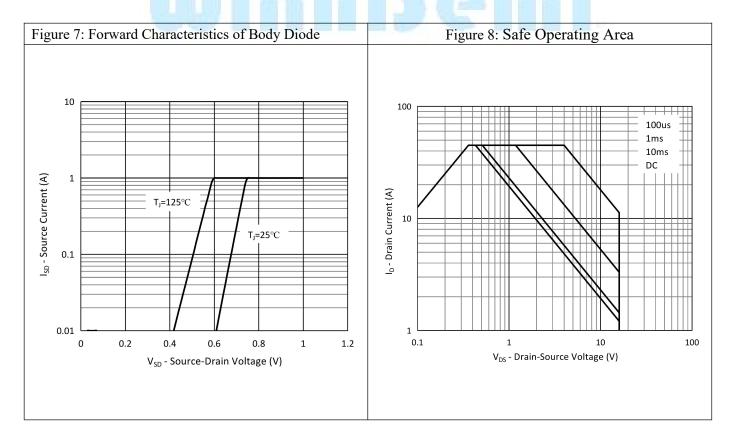


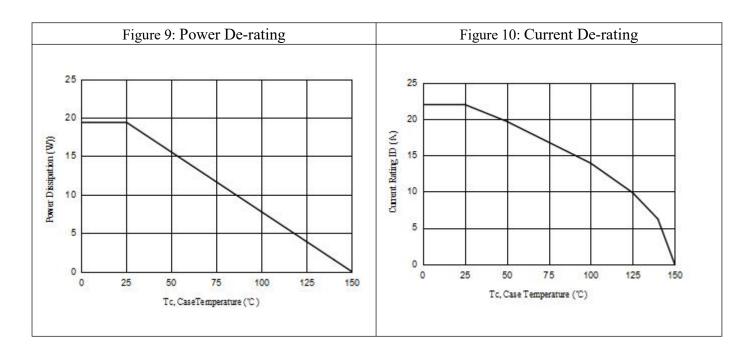
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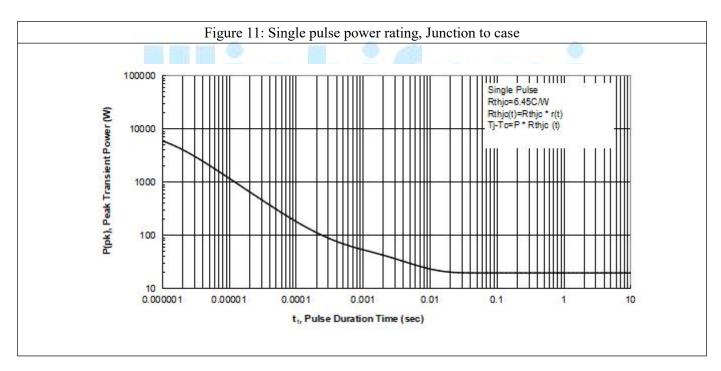
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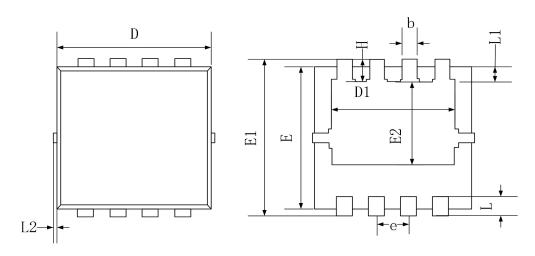


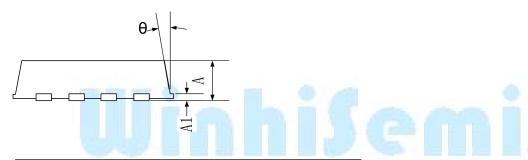






Mechanical Dimensions (PDFN3.3*3.3 Unit:mm)





SYMBOL	MILLIMETERS		
STIVIBUL	MIN	MAX	
Α	0.70	0.90	
A1	0.10	0.25	
D	2.90	3.25	
D1	2.25	2.69	
E	2.90	3.20	
E1	3.00	3.60	
E2	1.35	2.20	
b	0.20	0.40	
е	0.65BSC		
L	0.30	0.50	
L1	0.13BSC		
L2	0.00	0.20	
Н	0.15 0.65		
θ	0° 14°		

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Chengdu Winhi Semiconductor Co., LTD

Main Sites:

- Headquarters

Hangzhou Via-Media Semiconductor Co., LTD. 1305-1306, Building 71, No. 90, Wensan Road, Xihu District, Hangzhou, Zhejiang Province, P.R. China Tel: +86-0571-8515 0563

- Shanghai

Shanghai R&D Center. 1506~1508, Xinyin Building, 888 Yishan Road, Shanghai, P.R of China Tel: +86-021-54201999

- Xi'an

Xi'an R&D Center 1703B, Building A, Greenland Center, Jinye Road, High-Tech Zone, Xi'an, Shaanxi, P.R of China

- Chengdu Office

Chengdu Winhi Semiconductor Co., LTD. Floor 15, Building 5, No. 171, Hele 2nd Street, Chengdu, Sichuan Province, P.R. China Tel: +86-028-8505 0771

- Shenzhen

Shenzhen Sales Center. 17B, No.1 Phoenix Building, 2008 Shennan Road, Shenzhen, P.R of China Tel: +86-0755-82570682